





# DNP1105W Surface Mount IRED/Dome Lens Type

#### **Features**

Catares	
Package	3216 Dome lens type, Water clear epoxy
Product features	<ul> <li>Outer Dimension 3.2 x 1.6 x 1.85mm (LxWxH)</li> <li>High Radiant Intensity: 4.0mW/sr TYP. (I<sub>F</sub>=20mA)</li> <li>Total Output Power: 2mW TYP. (I<sub>F</sub>=20mA)</li> <li>Surface Mount Type and Reverse Mount Type are possible.</li> <li>Lead-free soldering compatible</li> <li>RoHS compliant</li> </ul>
Peak Wavelength	880nm
Half Intensity Angle	30 deg.
Die materials	GaAlAs
Rank grouping parameter	Sorted by radiant intensity per rank taping
Assembly method	Auto pick & place machine (Auto Mounter)
Soldering methods	Reflow soldering and manual soldering  **Please refer to Soldering Conditions about soldering.
Taping and reel	2,000pcs per reel in a 8mm width tape. (Standard) Reel diameter: $\phi$ 180mm
ESD	2kV (HBM)

# **Recommended Applications**

Car Audio, Electric Household Appliances, OA/FA, PC/Peripheral Equipment, Other General Applications

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### Absolute Maximum Ratings

(Ta=25℃)

Item	Symbol	<b>Absolute Maximum Ratings</b>	Unit
Power Dissipation	Pd	80	mW
Forward Current	I <sub>F</sub>	50	mA
Pulse Forward Current **1	I <sub>FRM</sub>	300	mA
Derating (Ta=25℃ or higher)	⊿I <sub>F</sub>	0.67	mA/℃
	⊿I <sub>FRM</sub>	4	mA/℃
Reverse Voltage	$V_R$	5	V
Operating Temperature	T <sub>opr</sub>	-30~+85	C
Storage Temperature	T <sub>stg</sub>	-40~+100	C

**<sup>%1</sup>** IFRM Measurement condition: Pulse Width≤100 μ s, Duty≤1/100

# **Electro-Optical Characteristics**

(Ta=25℃)

ltem		Completel			11	
item	Conditions	Symbol	Characteristics		Unit	
- IV k	I 20 A	V <sub>F</sub>	TYP.	1.35	V	
Forward Voltage	I <sub>F</sub> =20mA		MAX.	1.6		
Reverse Current	V <sub>R</sub> =5V	I <sub>R</sub>	MAX.	100	μΑ	
D. P. 41.4 14		I <sub>E</sub>	MIN.	2	mW/sr	
Radiant Intensity	I <sub>F</sub> =20mA		TYP.	4		
Total Output Power	I <sub>F</sub> =20mA	Po	TYP.	2	mW	
Peak Wavelength	I <sub>F</sub> =20mA	λp	TYP.	880	nm	
Spectral Half-width	I <sub>F</sub> =20mA	Δλ	TYP.	40	nm	
Half Intensity Angle	I <sub>F</sub> =20mA	2 θ 1/2	TYP.	30	deg.	
C-1-66 F	$I_F=20\text{mA}_{DC}\pm5\text{mA}$	fc	MIN.	-		
Cut-off Frequency	-3db from 0.1MHz		TYP.	12	MHz	
Response Time	I <sub>F</sub> =20mA	tr/tf	TYP.	30	ns	





# Radiant Intensity Rank

(Ta=25℃)

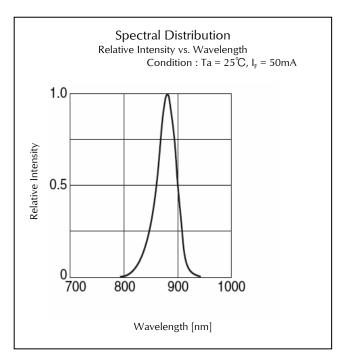
Rank	I <sub>E</sub> (m	Condition	
Kalik	MIN.	MAX.	Condition
A	2.0	4.0	
В	2.8	5.6	
С	4.0	8.0	I <sub>F</sub> = 20mA
D	5.6	11.2	
E	8.0	16.0	

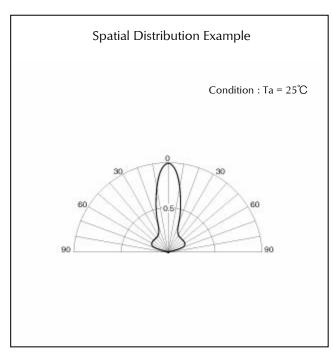
<sup>\*\*</sup>Please contact our sales staff concerning rank designation.

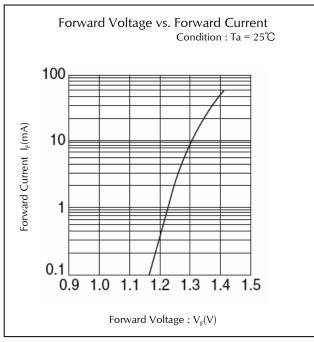


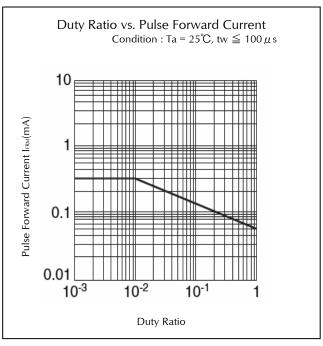


#### **Technical Data**







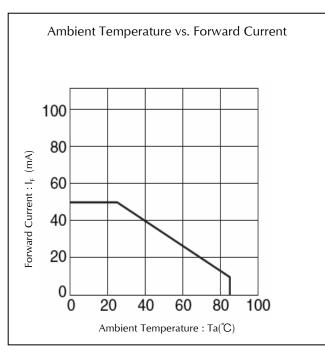


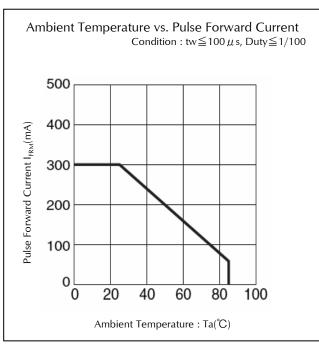
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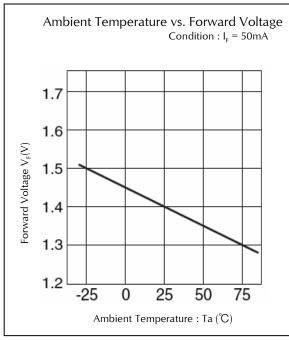


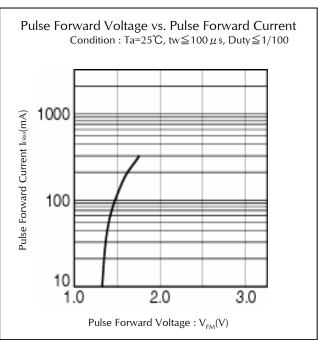


#### **Technical Data**





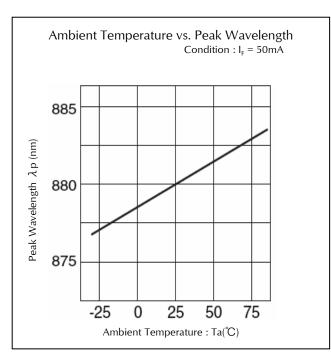


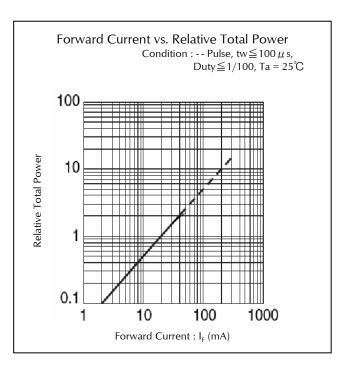


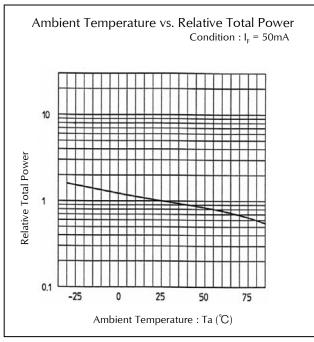


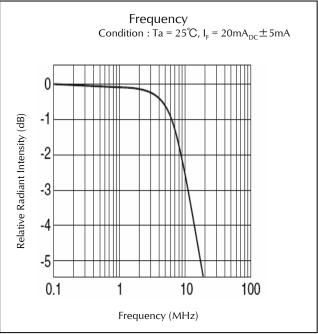


#### **Technical Data**









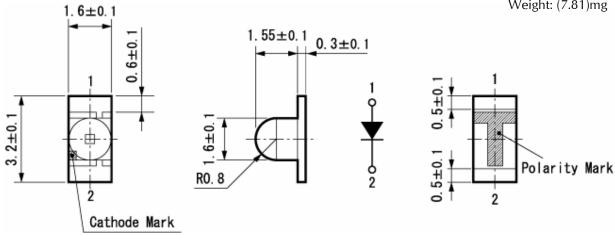




### Package Dimensions

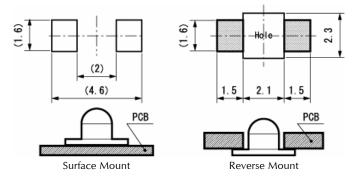
(Unit: mm)

Weight: (7.81)mg



### Recommended Soldering Pattern

(Unit: mm)



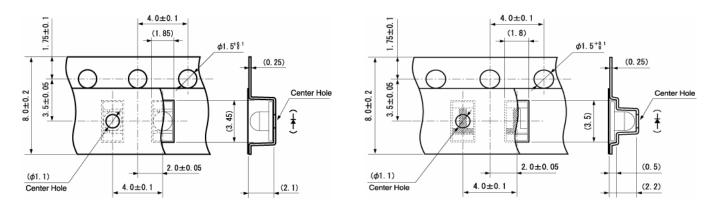
# **Taping Specification**

(Unit: mm)

Quantity: 2,000pcs/ reel (standard)

#### 1105W-TR (Surface Mount)

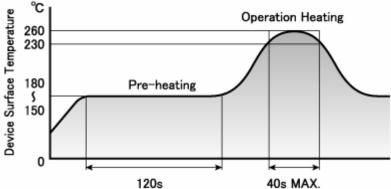
#### 1105W-RR (Reverse Mount)







#### **Reflow Soldering Conditions**



- 1) The above profile temperature gives the maximum temperature of the LED resin surface. Please set the temperature so as to avoid exceeding this range.
- 2) Total times of reflow soldering process shall be no more than 2 times. When the second reflow soldering process is performed, intervals between the first and second reflow should be short as possible (while allowing some time for the component to return to normal temperature after the first reflow) in order to prevent the LED from absorbing moisture.
- 3) Temperature fluctuation to the LED during the pre-heating process shall be minimized.

#### **Manual Soldering Conditions**

Iron tip temp.	350 ℃	(MAX.) (30 W Max.)
Soldering time and frequency	3 s 1 time	(MAX.) (MAX.)

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# Reliability Testing Result

Reliability Testing Result	Applicable Standard	Testing Conditions	Duration	Failure
Room Temp. Operating Life	EIAJ ED- 4701/100(101)	Ta = 25°C, IF = Maxium Rated Current	1,000 h	0/25
Resistance to Soldering Heat	EIAJ ED- 4701/300(301)	(Pretreatment) Individual standard (Reflow Soldering) Pre-heating 150°C∼180°C 120s Operating Heating 230°C Min. Peak temperature 260°C	Twice	0/25
Temperature Cycling	EIAJ ED- 4701/100(105)	Minimum Rated Storage Temperature(30min)  Normal Temperature(15min)  Maximum Rated Storage Temperature(30min)  Normal Temperature(15min)	5 cycles	0/25
Wet High Temp. Storage Life	EIAJ ED- 4701/100(103)	$T_a = 60 \pm 2^{\circ}C$ , RH = $90 \pm 5\%$	1,000 h	0/25
High Temp. Storage Life	EIAJ ED- 4701/200(201)	Ta = Maximum Rated Storage Temperature	1,000 h	0/25
Low Temp. Storage Life	EIAJ ED- 4701/200(202)	Ta = Minimum Rated Storage Temperature	1,000 h	0/25
Vibration, Variable Frequency	EIAJ ED- 4701/400(403)	98.1m/s <sup>2</sup> (10G), 100 ~ 2KHz sweep for 20min., XYZ each direction	2 h	0/10

# Failure Criteria

Items	Symbols	Conditions	Failure criteria
Radiant Intensity	I <sub>E</sub>	IF Value of each product Radiant Intensity	Testing Min. Value < Initial Value x 0.5
Forward Voltage	VF	IF Value of each product Forward Voltage	Testing Max. Value > Spec. Max. Value x 1.2
Reverse Current	<b>I</b> R	Vr = Maximum Rated Reverse Voltage V	Testing Max. Value ≧ Spec. Max. Value x 2.5

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